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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

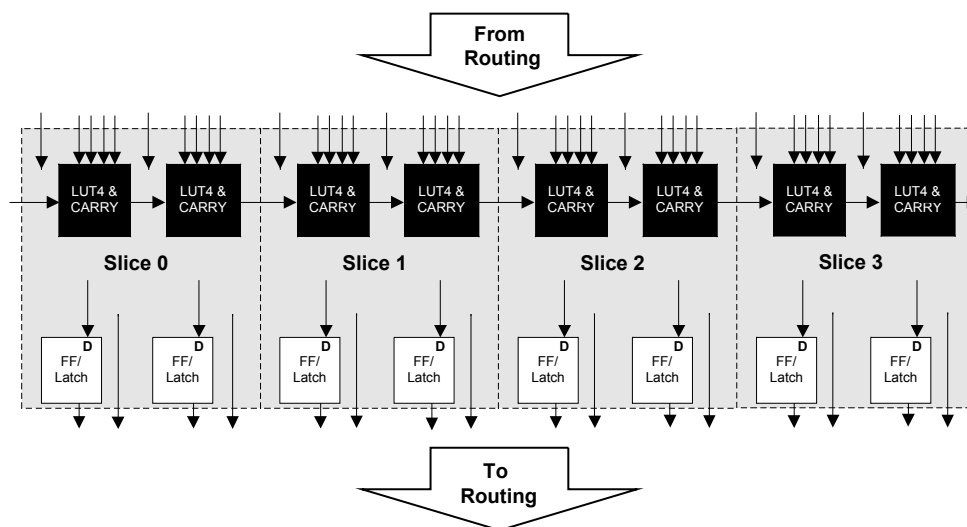
Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	10200
Total RAM Bits	282624
Number of I/O	288
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfec10e-5f484c

PFU and PFF Blocks

The core of the LatticeECP/EC devices consists of PFU and PFF blocks. The PFUs can be programmed to perform Logic, Arithmetic, Distributed RAM and Distributed ROM functions. PFF blocks can be programmed to perform Logic, Arithmetic and ROM functions. Except where necessary, the remainder of the data sheet will use the term PFU to refer to both PFU and PFF blocks.

Each PFU block consists of four interconnected slices, numbered 0-3 as shown in Figure 2-3. All the interconnections to and from PFU blocks are from routing. There are 53 inputs and 25 outputs associated with each PFU block.

Figure 2-3. PFU Diagram



Slice

Each slice contains two LUT4 lookup tables feeding two registers (programmed to be in FF or Latch mode), and some associated logic that allows the LUTs to be combined to perform functions such as LUT5, LUT6, LUT7 and LUT8. There is control logic to perform set/reset functions (programmable as synchronous/asynchronous), clock select, chip-select and wider RAM/ROM functions. Figure 2-4 shows an overview of the internal logic of the slice. The registers in the slice can be configured for positive/negative and edge/level clocks.

There are 14 input signals: 13 signals from routing and one from the carry-chain (from adjacent slice or PFU). There are 7 outputs: 6 to routing and one to carry-chain (to adjacent PFU). Table 2-1 lists the signals associated with each slice.

Signed and Unsigned with Different Widths

The DSP block supports different widths of signed and unsigned multipliers besides x9, x18 and x36 widths. For unsigned operands, unused upper data bits should be filled to create a valid x9, x18 or x36 operand. For signed two's complement operands, sign extension of the most significant bit should be performed until x9, x18 or x36 width is reached. Table 2-8 provides an example of this.

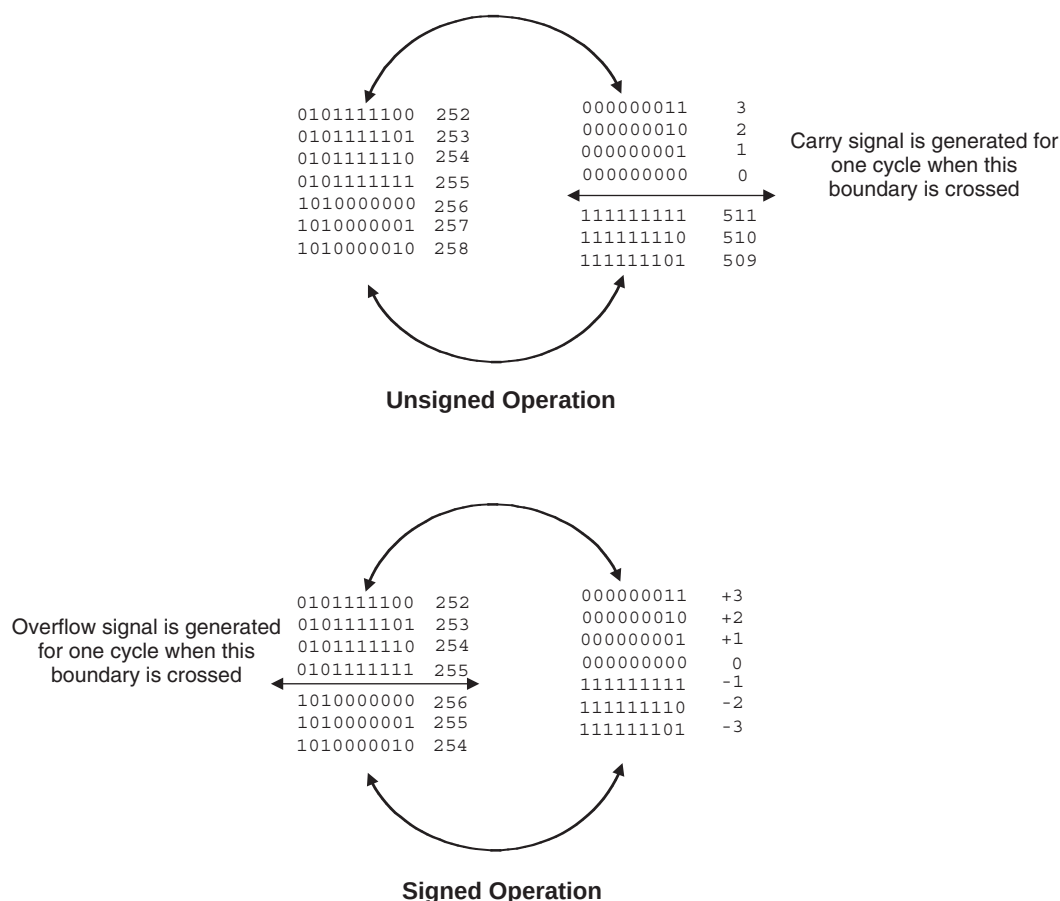
Table 2-8. An Example of Sign Extension

Number	Unsigned	Unsigned 9-bit	Unsigned 18-bit	Signed	Two's Complement Signed 9-Bits	Two's Complement Signed 18-bits
+5	0101	000000101	000000000000000101	0101	000000101	000000000000000101
-6	0110	000000110	000000000000000110	1010	111111010	111111111111111010

OVERFLOW Flag from MAC

The sysDSP block provides an overflow output to indicate that the accumulator has overflowed. When two unsigned numbers are added and the result is a smaller number then accumulator roll over is said to occur and overflow signal is indicated. When two positive numbers are added with a negative sum and when two negative numbers are added with a positive sum, then the accumulator “roll-over” is said to have occurred and an overflow signal is indicated. Note when overflow occurs the overflow flag is present for only one cycle. By counting these overflow pulses in FPGA logic, larger accumulators can be constructed. The conditions overflow signals for signed and unsigned operands are listed in Figure 2-23.

Figure 2-23. Accumulator Overflow/Underflow Conditions

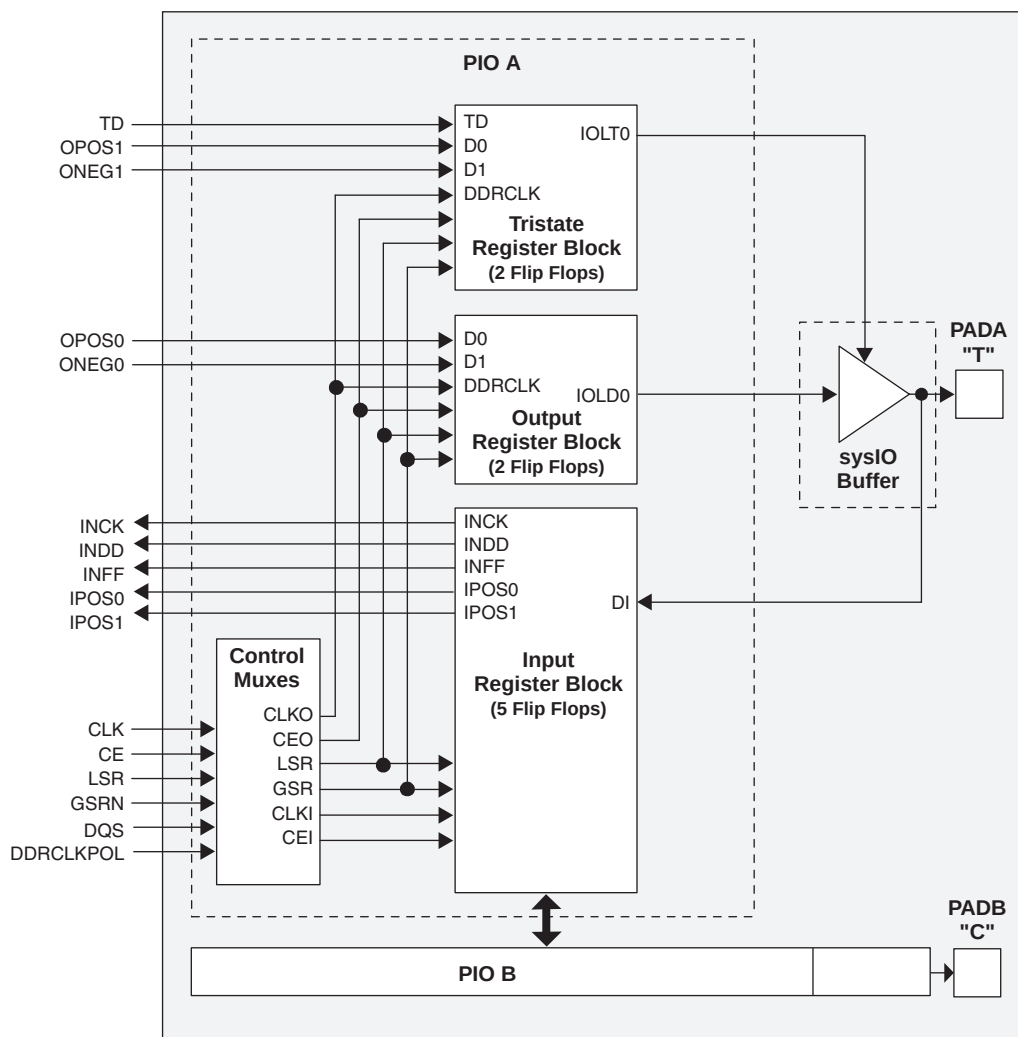


For further information about the sysDSP block, please see the list of technical information at the end of this data sheet.

Programmable I/O Cells (PIC)

Each PIC contains two PIOs connected to their respective sysI/O Buffers which are then connected to the PADs as shown in Figure 2-24. The PIO Block supplies the output data (DO) and the Tri-state control signal (TO) to sysI/O buffer, and receives input from the buffer.

Figure 2-24. PIC Diagram



Two adjacent PIOs can be joined to provide a differential I/O pair (labeled as “T” and “C”) as shown in Figure 2-25. The PAD Labels “T” and “C” distinguish the two PIOs. Only the PIO pairs on the left and right edges of the device can be configured as LVDS transmit/receive pairs.

One of every 16 PIOs contains a delay element to facilitate the generation of DQS signals. The DQS signal feeds the DQS bus which spans the set of 16 PIOs. Figure 2-25 shows the assignment of DQS pins in each set of 16 PIOs. The exact DQS pins are shown in a dual function in the Logic Signal Connections table at the end of this data sheet. Additional detail is provided in the Signal Descriptions table at the end of this data sheet. The DQS signal from the bus is used to strobe the DDR data from the memory into input register blocks. This interface is designed for memories that support one DQS strobe per eight bits of data.

Figure 2-29. Output Register Block

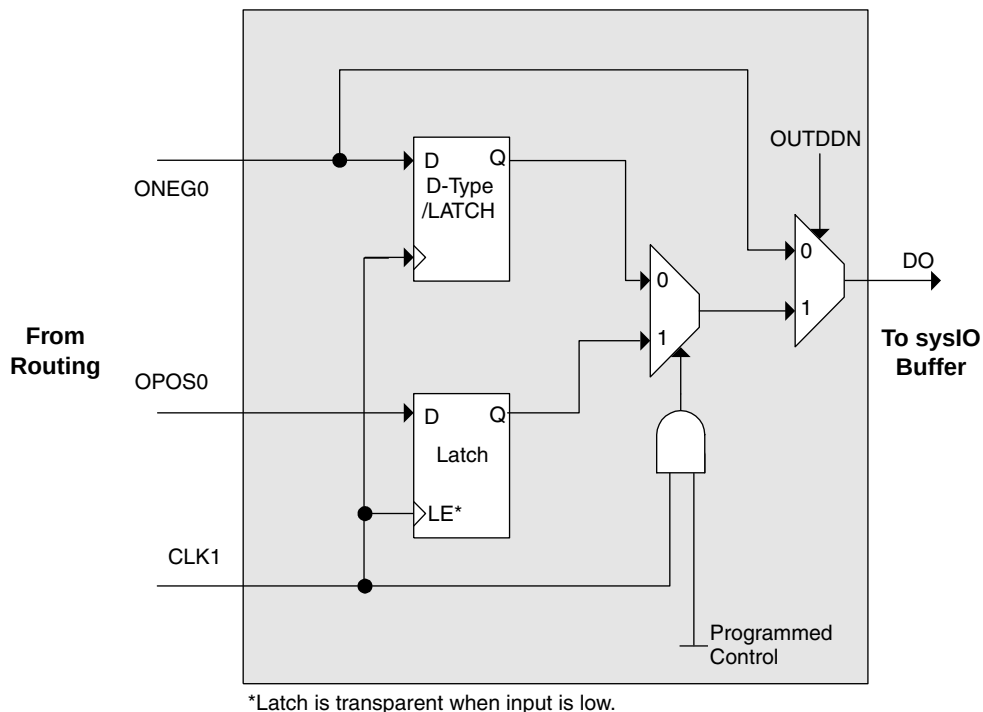
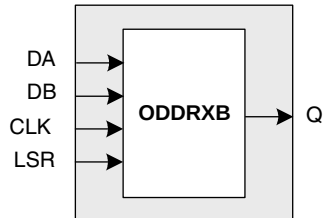


Figure 2-30. ODDRXB Primitive



Tristate Register Block

The tristate register block provides the ability to register tri-state control signals from the core of the device before they are passed to the sysI/O buffers. The block contains a register for SDR operation and an additional latch for DDR operation. Figure 2-31 shows the diagram of the Tristate Register Block.

In SDR mode, ONEG1 feeds one of the flip-flops that then feeds the output. The flip-flop can be configured a D-type or latch. In DDR mode, ONEG1 is fed into one register on the positive edge of the clock and OPOS1 is latched. A multiplexer running off the same clock selects the correct register for feeding to the output (D0).

sysI/O Differential Electrical Characteristics

LVDS

Over Recommended Operating Conditions

Parameter Symbol	Parameter Description	Test Conditions	Min.	Typ.	Max.	Units
V_{INP}, V_{INM}	Input voltage		0	—	2.4	V
V_{THD}	Differential input threshold		+/-100	—	—	mV
V_{CM}	Input common mode voltage	100mV δV_{THD}	$V_{THD}/2$	1.2	1.8	V
		200mV δV_{THD}	$V_{THD}/2$	1.2	1.9	V
		350mV δV_{THD}	$V_{THD}/2$	1.2	2.0	V
I_{IN}	Input current	Power on or power off	—	—	+/-10	μA
V_{OH}	Output high voltage for V_{OP} or V_{OM}	$R_T = 100 \text{ Ohm}$	—	1.38	1.60	V
V_{OL}	Output low voltage for V_{OP} or V_{OM}	$R_T = 100 \text{ Ohm}$	0.9V	1.03	—	V
V_{OD}	Output voltage differential	$(V_{OP} - V_{OM}), R_T = 100 \text{ Ohm}$	250	350	450	mV
ΔV_{OD}	Change in V_{OD} between high and low		—	—	50	mV
V_{OS}	Output voltage offset	$(V_{OP} + V_{OM})/2, R_T = 100 \text{ Ohm}$	1.125	1.25	1.375	V
ΔV_{OS}	Change in V_{OS} between H and L		—	—	50	mV
I_{OSD}	Output short circuit current	$V_{OD} = 0V$ Driver outputs shorted	—	—	6	mA

LVPECL

The LatticeECP/EC devices support differential LVPECL standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The LVPECL input standard is supported by the LVDS differential input buffer. The scheme shown in Figure 3-3 is one possible solution for point-to-point signals.

Figure 3-3. Differential LVPECL

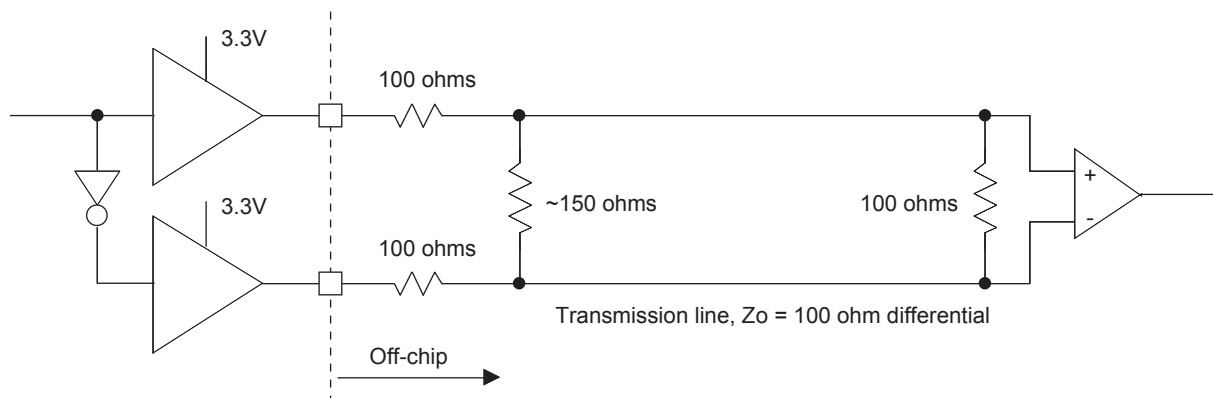


Table 3-3. LVPECL DC Conditions¹

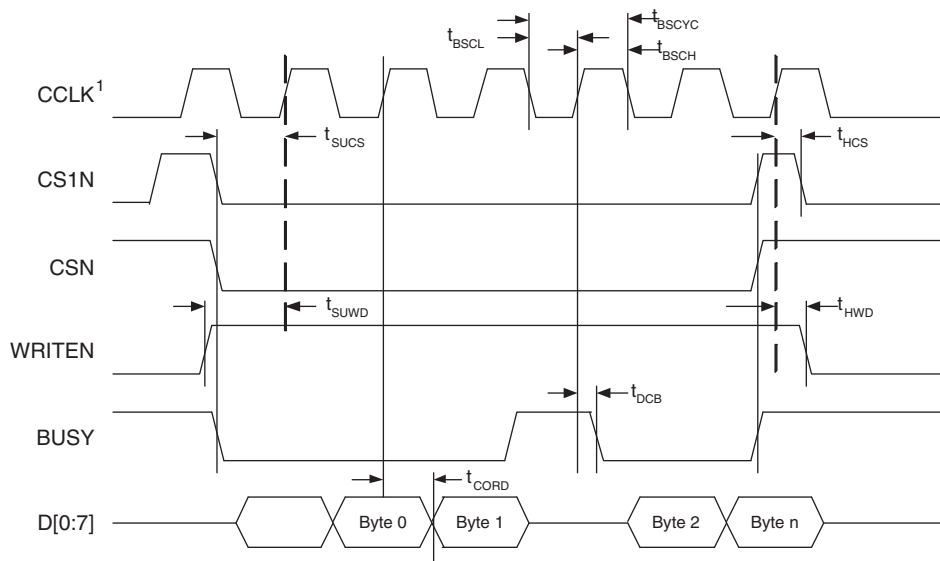
Over Recommended Operating Conditions

Parameter	Description	Typical	Units
Z_{OUT}	Output impedance	100	ohm
R_P	Driver parallel resistor	150	ohm
R_T	Receiver termination	100	ohm
V_{OH}	Output high voltage	2.03	V
V_{OL}	Output low voltage	1.27	V
V_{OD}	Output differential voltage	0.76	V
V_{CM}	Output common mode voltage	1.65	V
Z_{BACK}	Back impedance	85.7	ohm
I_{DC}	DC output current	12.7	mA

1. For input buffer, see LVDS table.

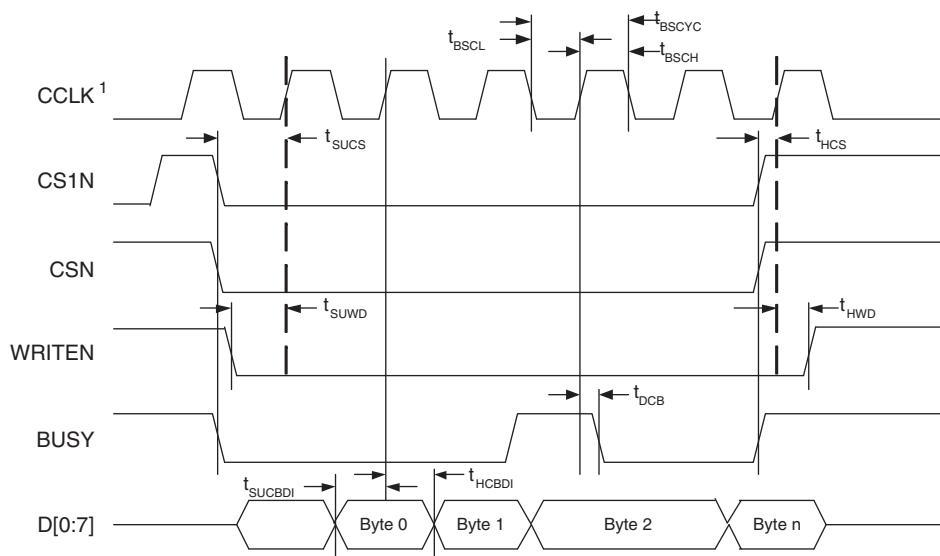
For further information about LVPECL, BLVDS and other differential interfaces please see the list of technical information at the end of this data sheet.

Figure 3-12. sysCONFIG Parallel Port Read Cycle



1. In Master Parallel Mode the FPGA provides CCLK. In Slave Parallel Mode the external device provides CCLK.

Figure 3-13. sysCONFIG Parallel Port Write Cycle

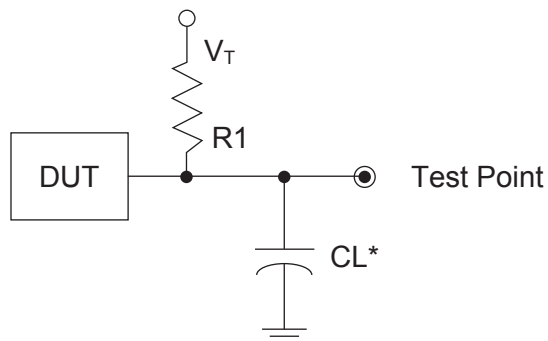


1. In Master Parallel Mode the FPGA provides CCLK. In Slave Parallel Mode the external device provides CCLK.

Switching Test Conditions

Figure 3-21 shows the output test load that is used for AC testing. The specific values for resistance, capacitance, voltage, and other test conditions are shown in Table 3-6.

Figure 3-21. Output Test Load, LVTTTL and LVCMOS Standards



*CL Includes Test Fixture and Probe Capacitance

Table 3-6. Test Fixture Required Components, Non-Terminated Interfaces

Test Condition	R_1	C_L	Timing Ref.	V_T
LVTTTL and other LVCMOS settings (L -> H, H -> L)	∞	0pF	LVCMOS 3.3 = 1.5V	—
			LVCMOS 2.5 = $V_{CCIO}/2$	—
			LVCMOS 1.8 = $V_{CCIO}/2$	—
			LVCMOS 1.5 = $V_{CCIO}/2$	—
			LVCMOS 1.2 = $V_{CCIO}/2$	—
LVCMOS 2.5 I/O (Z -> H)	188 $\frac{3}{4}$	0pF	$V_{CCIO}/2$	V_{OL}
LVCMOS 2.5 I/O (Z -> L)			$V_{CCIO}/2$	V_{OH}
LVCMOS 2.5 I/O (H -> Z)			$V_{OH} - 0.15$	V_{OL}
LVCMOS 2.5 I/O (L -> Z)			$V_{OL} + 0.15$	V_{OH}

Note: Output test conditions for all other interfaces are determined by the respective standards.

Signal Descriptions

Signal Name	I/O	Description
General Purpose		
P[Edge] [Row/Column Number*]_[A/B]	I/O	[Edge] indicates the edge of the device on which the pad is located. Valid edge designations are L (Left), B (Bottom), R (Right), T (Top). [Row/Column Number] indicates the PFU row or the column of the device on which the PIC exists. When Edge is T (Top) or (Bottom), only need to specify Row Number. When Edge is L (Left) or R (Right), only need to specify Column Number. [A/B] indicates the PIO within the PIC to which the pad is connected. Some of these user-programmable pins are shared with special function pins. These pin when not used as special purpose pins can be programmed as I/Os for user logic. During configuration the user-programmable I/Os are tri-stated with an internal pull-up resistor enabled. If any pin is not used (or not bonded to a package pin), it is also tri-stated with an internal pull-up resistor enabled after configuration.
GSRN	I	Global RESET signal (active low). Any I/O pin can be GSRN.
NC	—	No connect.
GND	—	Ground. Dedicated pins.
V _{CC}	—	Power supply pins for core logic. Dedicated pins.
V _{CCAUX}	—	Auxiliary power supply pin. It powers all the differential and referenced input buffers. Dedicated pins.
V _{CCIOx}	—	Power supply pins for I/O bank x. Dedicated pins.
V _{REF1_x} , V _{REF2_x}	—	Reference supply pins for I/O bank x. Pre-determined pins in each bank are assigned as V _{REF} inputs. When not used, they may be used as I/O pins.
XRES	—	10K ohm +/-1% resistor must be connected between this pad and ground.
V _{CCPLL}	—	Power supply pin for PLL. Applicable to ECP/EC33 device.
PLL and Clock Functions (Used as user programmable I/O pins when not in use for PLL or clock pins)		
[LOC][num]_PLL[T, C]_IN_A	I	Reference clock (PLL) input pads: ULM, LLM, URM, LRM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_PLL[T, C]_FB_A	I	Optional feedback (PLL) input pads: ULM, LLM, URM, LRM, num = row from center, T = true and C = complement, index A,B,C...at each side.
PCLK[T, C]_[n:0]_[3:0]	I	Primary Clock pads, T = true and C = complement, n per side, indexed by bank and 0,1,2,3 within bank.
[LOC]DQS[num]	I	DQS input pads: T (Top), R (Right), B (Bottom), L (Left), DQS, num = ball function number. Any pad can be configured to be output.
Test and Programming (Dedicated pins)		
TMS	I	Test Mode Select input, used to control the 1149.1 state machine. Pull-up is enabled during configuration.
TCK	I	Test Clock input pin, used to clock the 1149.1 state machine. No pull-up enabled.

LFEC1, LFEC3 Logic Signal Connections: 100 TQFP

Pin Number	LFEC1				LFEC3			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
1*	GND0 GND7	-			GND0 GND7	-		
2	VCCIO7	7			VCCIO7	7		
3	PL2A	7	T	VREF2_7	PL2A	7	T	VREF2_7
4	PL2B	7	C	VREF1_7	PL2B	7	C	VREF1_7
5	PL3A	7	T		PL7A	7	T	
6	PL3B	7	C		PL7B	7	C	
7	PL4A	7	T		PL8A	7	T	
8	PL4B	7	C		PL8B	7	C	
9	PL5A	7	T	PCLKT7_0	PL9A	7	T	PCLKT7_0
10	PL5B	7	C	PCLKC7_0	PL9B	7	C	PCLKC7_0
11	XRES	6			XRES	6		
12	VCC	-			VCC	-		
13	TCK	6			TCK	6		
14	GND	-			GND	-		
15	TDI	6			TDI	6		
16	TMS	6			TMS	6		
17	TDO	6			TDO	6		
18	VCCJ	6			VCCJ	6		
19	PL7A	6	T	LLM0_PLLT_IN_A	PL11A	6	T	LUM0_PLLT_IN_A
20	PL7B	6	C	LLM0_PLLC_IN_A	PL11B	6	C	LUM0_PLLC_IN_A
21	PL8A	6	T	LLM0_PLLT_FB_A	PL12A	6	T	LUM0_PLLT_FB_A
22	PL8B	6	C	LLM0_PLLC_FB_A	PL12B	6	C	LUM0_PLLC_FB_A
23	PL14A	6		VREF1_6	PL18A	6		VREF1_6
24	VCCIO6	6			VCCIO6	6		
25*	GND5 GND6	-			GND5 GND6	-		
26	VCCIO5	5			VCCIO5	5		
27	PB2A	5	T		PB10A	5	T	
28	PB2B	5	C		PB10B	5	C	
29	PB3A	5	T		PB11A	5	T	
30	PB3B	5	C		PB11B	5	C	
31	PB6A	5		BDQS6	PB14A	5		BDQS14
32	PB8A	5	T	VREF2_5	PB16A	5	T	VREF2_5
33	PB8B	5	C	VREF1_5	PB16B	5	C	VREF1_5
34	PB9A	5	T	PCLKT5_0	PB17A	5	T	PCLKT5_0
35	GND5	5			GND5	5		
36	PB9B	5	C	PCLKC5_0	PB17B	5	C	PCLKC5_0
37	VCCAUX	-			VCCAUX	-		
38	VCCIO4	4			VCCIO4	4		
39	PB10A	4	T	WRITEN	PB18A	4	T	WRITEN
40	PB10B	4	C	CS1N	PB18B	4	C	CS1N

LFEC6P/EC6, LFEC6P/EC10 Logic Signal Connections: 208 PQFP (Cont.)

Pin Number	LFEC6P/EC6				LFEC6P/EC10			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
85	VCCIO4	4			VCCIO4	4		
86	PB18A	4	T	WRITEN	PB26A	4	T	WRITEN
87	PB18B	4	C	CS1N	PB26B	4	C	CS1N
88	PB19A	4	T	VREF1_4	PB27A	4	T	VREF1_4
89	PB19B	4	C	CSN	PB27B	4	C	CSN
90	PB20A	4	T	VREF2_4	PB28A	4	T	VREF2_4
91	PB20B	4	C	D0/SPID7	PB28B	4	C	D0/SPID7
92	PB21A	4	T	D2/SPID5	PB29A	4	T	D2/SPID5
93	GND4	4			GND4	4		
94	PB21B	4	C	D1/SPID6	PB29B	4	C	D1/SPID6
95	PB22A	4	T	BDQS22	PB30A	4	T	BDQS30
96	PB22B	4	C	D3/SPID4	PB30B	4	C	D3/SPID4
97	PB23A	4	T		PB31A	4	T	
98	PB23B	4	C	D4/SPID3	PB31B	4	C	D4/SPID3
99	PB24A	4	T		PB32A	4	T	
100	PB24B	4	C	D5/SPID2	PB32B	4	C	D5/SPID2
101	PB25A	4	T		PB33A	4	T	
102	PB25B	4	C	D6/SPID1	PB33B	4	C	D6/SPID1
103	PB33A	4			PB41A	4		
104	VCCIO4	4			VCCIO4	4		
105*	GND3 GND4	-			GND3 GND4	-		
106	VCCIO3	3			VCCIO3	3		
107	PR27B	3	C	VREF2_3	PR36B	3	C	VREF2_3
108	PR27A	3	T	VREF1_3	PR36A	3	T	VREF1_3
109	PR26B	3	C		PR35B	3	C	
110	PR26A	3	T		PR35A	3	T	
111	PR25B	3	C		PR34B	3	C	
112	PR25A	3	T		PR34A	3	T	
113	PR24B	3	C		PR33B	3	C	
114	PR24A	3	T	RDQS24	PR33A	3	T	RDQS33
115	PR23B	3	C	RLM0_PLLC_FB_A	PR32B	3	C	RLM0_PLLC_FB_A
116	GND3	3			GND3	3		
117	PR23A	3	T	RLM0_PLLT_FB_A	PR32A	3	T	RLM0_PLLT_FB_A
118	PR22B	3	C	RLM0_PLLC_IN_A	PR31B	3	C	RLM0_PLLC_IN_A
119	PR22A	3	T	RLM0_PLLT_IN_A	PR31A	3	T	RLM0_PLLT_IN_A
120	VCCIO3	3			VCCIO3	3		
121	PR21B	3	C	DI/CSSPIN	PR30B	3	C	DI/CSSPIN
122	PR21A	3	T	DOUT/CSON	PR30A	3	T	DOUT/CSON
123	PR20B	3	C	BUSY/SISPI	PR29B	3	C	BUSY/SISPI
124	PR20A	3	T	D7/SPID0	PR29A	3	T	D7/SPID0
125	CFG2	3			CFG2	3		
126	CFG1	3			CFG1	3		

LFEC3 and LFECP/EC6 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFEC3				LFECP6/LFEC6			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
K2	PL11A	6	T	LLM0_PLLT_IN_A	PL20A	6	T	LLM0_PLLT_IN_A
K1	PL11B	6	C	LLM0_PLLC_IN_A	PL20B	6	C	LLM0_PLLC_IN_A
L2	PL12A	6	T	LLM0_PLLT_FB_A	PL21A	6	T	LLM0_PLLT_FB_A
L1	PL12B	6	C	LLM0_PLLC_FB_A	PL21B	6	C	LLM0_PLLC_FB_A
M2	PL13A	6	T		PL22A	6	T	
M1	PL13B	6	C		PL22B	6	C	
N1	PL14A	6	T		PL23A	6	T	
GND	GND6	6			GND6	6		
N2	PL14B	6	C		PL23B	6	C	
M4	PL15A	6	T	LDQS15	PL24A	6	T	LDQS24
M3	PL15B	6	C		PL24B	6	C	
P1	PL16A	6	T		PL25A	6	T	
R1	PL16B	6	C		PL25B	6	C	
P2	PL17A	6	T		PL26A	6	T	
P3	PL17B	6	C		PL26B	6	C	
N3	PL18A	6	T	VREF1_6	PL27A	6	T	VREF1_6
N4	PL18B	6	C	VREF2_6	PL27B	6	C	VREF2_6
GND	GND6	6			GND6	6		
GND	GND5	5			GND5	5		
P4	PB2A	5	T		PB2A	5	T	
N5	PB2B	5	C		PB2B	5	C	
P5	PB3A	5	T		PB3A	5	T	
P6	PB3B	5	C		PB3B	5	C	
R4	PB4A	5	T		PB4A	5	T	
R3	PB4B	5	C		PB4B	5	C	
T2	PB5A	5	T		PB5A	5	T	
T3	PB5B	5	C		PB5B	5	C	
R5	PB6A	5	T	BDQS6	PB6A	5	T	BDQS6
R6	PB6B	5	C		PB6B	5	C	
T4	PB7A	5	T		PB7A	5	T	
T5	PB7B	5	C		PB7B	5	C	
N6	PB8A	5	T		PB8A	5	T	
M6	PB8B	5	C		PB8B	5	C	
T6	PB9A	5	T		PB9A	5	T	
GND	GND5	5			GND5	5		
T7	PB9B	5	C		PB9B	5	C	
P7	PB10A	5	T		PB10A	5	T	
N7	PB10B	5	C		PB10B	5	C	
R7	PB11A	5	T		PB11A	5	T	
R8	PB11B	5	C		PB11B	5	C	
M7	PB12A	5	T		PB12A	5	T	
M8	PB12B	5	C		PB12B	5	C	
T8	PB13A	5	T		PB13A	5	T	

LFEC6/EC6, LFEC6/EC10, LFEC6/EC15 Logic Signal Connections: 484 fpBGA (Cont.)

LFEC6/LFEC6					LFEC10/LFEC10					LFEC15/LFEC15				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
T11	VCCIO5	5			T11	VCCIO5	5			T11	VCCIO5	5		
M7	VCCIO6	6			M7	VCCIO6	6			M7	VCCIO6	6		
M8	VCCIO6	6			M8	VCCIO6	6			M8	VCCIO6	6		
N8	VCCIO6	6			N8	VCCIO6	6			N8	VCCIO6	6		
P8	VCCIO6	6			P8	VCCIO6	6			P8	VCCIO6	6		
J8	VCCIO7	7			J8	VCCIO7	7			J8	VCCIO7	7		
K8	VCCIO7	7			K8	VCCIO7	7			K8	VCCIO7	7		
L7	VCCIO7	7			L7	VCCIO7	7			L7	VCCIO7	7		
L8	VCCIO7	7			L8	VCCIO7	7			L8	VCCIO7	7		
G15	VCCAUX	-			G15	VCCAUX	-			G15	VCCAUX	-		
G16	VCCAUX	-			G16	VCCAUX	-			G16	VCCAUX	-		
G7	VCCAUX	-			G7	VCCAUX	-			G7	VCCAUX	-		
G8	VCCAUX	-			G8	VCCAUX	-			G8	VCCAUX	-		
H16	VCCAUX	-			H16	VCCAUX	-			H16	VCCAUX	-		
H7	VCCAUX	-			H7	VCCAUX	-			H7	VCCAUX	-		
R16	VCCAUX	-			R16	VCCAUX	-			R16	VCCAUX	-		
R7	VCCAUX	-			R7	VCCAUX	-			R7	VCCAUX	-		
T15	VCCAUX	-			T15	VCCAUX	-			T15	VCCAUX	-		
T16	VCCAUX	-			T16	VCCAUX	-			T16	VCCAUX	-		
T7	VCCAUX	-			T7	VCCAUX	-			T7	VCCAUX	-		
T8	VCCAUX	-			T8	VCCAUX	-			T8	VCCAUX	-		
J6	VCC	-			J6	VCC	-			J6	VCC	-		
J17	VCC	-			J17	VCC	-			J17	VCC	-		
P6	VCC	-			P6	VCC	-			P6	VCC	-		
P17	VCC	-			P17	VCC	-			P17	VCC	-		
A2	NC	-			A2	NC	-			A2	NC	-		
AB2	NC	-			AB2	NC	-			AB2	NC	-		
A21	NC	-			A21	NC	-			A21	NC	-		

LFEC20/EC20 and LFEC20/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFEC20/LFEC20					LFEC20/LFEC33				
Ball Number	Ball Function	Bank	LVD S	Dual Function	Ball Number	Ball Function	Bank	LVD S	Dual Function
C22	PR9A	2	T	RUM0_PLLT_FB_A	C22	PR17A	2	T	RUM0_PLLT_FB_A
G19	PR8B	2	C	RUM0_PLLC_IN_A	G19	PR16B	2	C	RUM0_PLLC_IN_A
G18	PR8A	2	T	RUM0_PLLT_IN_A	G18	PR16A	2	T	RUM0_PLLT_IN_A
F20	PR7B	2	C		F20	PR15B	2	C	
F19	PR7A	2	T		F19	PR15A	2	T	
E20	PR6B	2	C		E20	PR14B	2	C	
D20	PR6A	2	T	RDQS6	D20	PR14A	2	T	RDQS14
C21	PR5B	2	C		C21	PR13B	2	C	
GND	-	-			GND	GND2	2		
C20	PR5A	2	T		C20	PR13A	2	T	
F18	PR4B	2	C		F18	PR12B	2	C	
E18	PR4A	2	T		E18	PR12A	2	T	
B22	PR3B	2	C		B22	PR11B	2	C	
B21	PR3A	2	T		B21	PR11A	2	T	
GND	-	-			GND	GND2	2		
E19	PR2B	2	C	VREF1_2	E19	PR2B	2	C	VREF1_2
D19	PR2A	2	T	VREF2_2	D19	PR2A	2	T	VREF2_2
GND	GND2	2			GND	GND2	2		
GND	GND1	1			GND	GND1	1		
GND	-	-			GND	GND1	1		
G17	PT57B	1	C		G17	PT57B	1	C	
GND	-	-			GND	GND1	1		
F17	PT57A	1	T		F17	PT57A	1	T	
D18	PT56B	1	C		D18	PT56B	1	C	
C18	PT56A	1	T		C18	PT56A	1	T	
C19	PT55B	1	C		C19	PT55B	1	C	
B20	PT55A	1	T		B20	PT55A	1	T	
D17	PT54B	1	C		D17	PT54B	1	C	
C16	PT54A	1	T	TDQS54	C16	PT54A	1	T	TDQS54
B19	PT53B	1	C		B19	PT53B	1	C	
GND	GND1	1			GND	GND1	1		
A20	PT53A	1	T		A20	PT53A	1	T	
E17	PT52B	1	C		E17	PT52B	1	C	
C17	PT52A	1	T		C17	PT52A	1	T	
F16	PT51B	1	C		F16	PT51B	1	C	
E16	PT51A	1	T		E16	PT51A	1	T	
F15	PT50B	1	C		F15	PT50B	1	C	
D16	PT50A	1	T		D16	PT50A	1	T	
B18	PT49B	1	C		B18	PT49B	1	C	
GND	GND1	1			GND	GND1	1		
A19	PT49A	1	T		A19	PT49A	1	T	
B17	PT48B	1	C		B17	PT48B	1	C	
A18	PT48A	1	T		A18	PT48A	1	T	
B16	PT47B	1	C		B16	PT47B	1	C	

LFECP/EC20 and LFECP/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFECP20/LFEC20					LFECP/LFEC33				
Ball Number	Ball Function	Bank	LVD S	Dual Function	Ball Number	Ball Function	Bank	LVD S	Dual Function
L7	VCCIO7	7			L7	VCCIO7	7		
L8	VCCIO7	7			L8	VCCIO7	7		
G15	VCCAUX	-			G15	VCCAUX	-		
G16	VCCAUX	-			G16	VCCAUX	-		
G7	VCCAUX	-			G7	VCCAUX	-		
G8	VCCAUX	-			G8	VCCAUX	-		
H16	VCCAUX	-			H16	VCCAUX	-		
H7	VCCAUX	-			H7	VCCAUX	-		
R16	VCCAUX	-			R16	VCCAUX	-		
R7	VCCAUX	-			R7	VCCAUX	-		
T15	VCCAUX	-			T15	VCCAUX	-		
T16	VCCAUX	-			T16	VCCAUX	-		
T7	VCCAUX	-			T7	VCCAUX	-		
T8	VCCAUX	-			T8	VCCAUX	-		
J6	VCC ¹	-			J6	VCCPLL	-		
J17	VCC ¹	-			J17	VCCPLL	-		
P6	VCC ¹	-			P6	VCCPLL	-		
P17	VCC ¹	-			P17	VCCPLL	-		
A2	NC	-			A2	NC	-		
AB2	NC	-			AB2	NC	-		
A21	NC	-			A21	NC	-		

1. Tied to V_{CCPLL}.

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
AC13	PB32B	5	C	VREF1_5	AC13	PB32B	5	C	VREF1_5
AF14	PB33A	5	T	PCLKT5_0	AF14	PB33A	5	T	PCLKT5_0
GND	GND5	5			GND	GND5	5		
AE14	PB33B	5	C	PCLKC5_0	AE14	PB33B	5	C	PCLKC5_0
AA13	PB34A	4	T	WRITEN	AA13	PB34A	4	T	WRITEN
AB13	PB34B	4	C	CS1N	AB13	PB34B	4	C	CS1N
AD14	PB35A	4	T	VREF1_4	AD14	PB35A	4	T	VREF1_4
AA14	PB35B	4	C	CSN	AA14	PB35B	4	C	CSN
AC14	PB36A	4	T	VREF2_4	AC14	PB36A	4	T	VREF2_4
AB14	PB36B	4	C	D0/SPID7	AB14	PB36B	4	C	D0/SPID7
AF15	PB37A	4	T	D2/SPID5	AF15	PB37A	4	T	D2/SPID5
GND	GND4	4			GND	GND4	4		
AE15	PB37B	4	C	D1/SPID6	AE15	PB37B	4	C	D1/SPID6
AD15	PB38A	4	T	BDQS38	AD15	PB38A	4	T	BDQS38
AC15	PB38B	4	C	D3/SPID4	AC15	PB38B	4	C	D3/SPID4
AF16	PB39A	4	T		AF16	PB39A	4	T	
Y14	PB39B	4	C	D4/SPID3	Y14	PB39B	4	C	D4/SPID3
AE16	PB40A	4	T		AE16	PB40A	4	T	
AB15	PB40B	4	C	D5/SPID2	AB15	PB40B	4	C	D5/SPID2
AF17	PB41A	4	T		AF17	PB41A	4	T	
GND	GND4	4			GND	GND4	4		
AE17	PB41B	4	C	D6/SPID1	AE17	PB41B	4	C	D6/SPID1
Y15	PB42A	4	T		Y15	PB42A	4	T	
AA15	PB42B	4	C		AA15	PB42B	4	C	
AD17	PB43A	4	T		AD17	PB43A	4	T	
Y16	PB43B	4	C		Y16	PB43B	4	C	
AD18	PB44A	4	T		AD18	PB44A	4	T	
AC16	PB44B	4	C		AC16	PB44B	4	C	
AE18	PB45A	4	T		AE18	PB45A	4	T	
GND	GND4	4			GND	GND4	4		
AF18	PB45B	4	C		AF18	PB45B	4	C	
AD16	PB46A	4	T	BDQS46	AD16	PB46A	4	T	BDQS46
AB16	PB46B	4	C		AB16	PB46B	4	C	
AF19	PB47A	4	T		AF19	PB47A	4	T	
AA16	PB47B	4	C		AA16	PB47B	4	C	
AA17	PB48A	4	T		AA17	PB48A	4	T	
Y17	PB48B	4	C		Y17	PB48B	4	C	
AF21	PB49A	4	T		AF21	PB49A	4	T	
GND	GND4	4			GND	GND4	4		
AF20	PB49B	4	C		AF20	PB49B	4	C	
AE21	PB50A	4	T		AE21	PB50A	4	T	
AC17	PB50B	4	C		AC17	PB50B	4	C	

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
E24	NC	-			E24	PR8B	2	C	
D24	NC	-			D24	PR8A	2	T	
E22	NC	-			E22	PR7B	2	C	
F22	NC	-			F22	PR7A	2	T	
E21	NC	-			E21	PR6B	2	C	
D22	NC	-			D22	PR6A	2	T	RDQS6
E23	PR2B	2	C	VREF1_2	E23	PR2B	2	C	VREF1_2
D23	PR2A	2	T	VREF2_2	D23	PR2A	2	T	VREF2_2
GND	GND2	2			GND	GND2	2		
GND	GND1	1			GND	GND1	1		
G20	NC	-			G20	PT65B	1	C	
F20	NC	-			F20	PT65A	1	T	
D21	NC	-			D21	PT64B	1	C	
C21	NC	-			C21	PT64A	1	T	
C23	NC	-			C23	PT63B	1	C	
C22	NC	-			C22	PT63A	1	T	
B23	NC	-			B23	PT62B	1	C	
C24	NC	-			C24	PT62A	1	T	TDQS62
D20	NC	-			D20	PT61B	1	C	
-	-	-			GND	GND1	1		
E19	NC	-			E19	PT61A	1	T	
B25	NC	-			B25	PT60B	1	C	
B24	NC	-			B24	PT60A	1	T	
B26	NC	-			B26	PT59B	1	C	
A25	NC	-			A25	PT59A	1	T	
C20	NC	-			C20	PT58B	1	C	
C19	NC	-			C19	PT58A	1	T	
A24	PT57B	1	C		A24	PT57B	1	C	
-	-	-			GND	GND1	1		
A23	PT57A	1	T		A23	PT57A	1	T	
E18	PT56B	1	C		E18	PT56B	1	C	
D19	PT56A	1	T		D19	PT56A	1	T	
F19	PT55B	1	C		F19	PT55B	1	C	
B22	PT55A	1	T		B22	PT55A	1	T	
G19	PT54B	1	C		G19	PT54B	1	C	
B21	PT54A	1	T	TDQS54	B21	PT54A	1	T	TDQS54
D18	PT53B	1	C		D18	PT53B	1	C	
GND	GND1	1			GND	GND1	1		
C18	PT53A	1	T		C18	PT53A	1	T	
F18	PT52B	1	C		F18	PT52B	1	C	
A22	PT52A	1	T		A22	PT52A	1	T	
G18	PT51B	1	C		G18	PT51B	1	C	

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
U12	GND	-			U12	GND	-		
U13	GND	-			U13	GND	-		
U14	GND	-			U14	GND	-		
U15	GND	-			U15	GND	-		
U16	GND	-			U16	GND	-		
U17	GND	-			U17	GND	-		
H10	VCC	-			H10	VCC	-		
H11	VCC	-			H11	VCC	-		
H16	VCC	-			H16	VCC	-		
H17	VCC	-			H17	VCC	-		
H18	VCC	-			H18	VCC	-		
H19	VCC	-			H19	VCC	-		
H8	VCC	-			H8	VCC	-		
H9	VCC	-			H9	VCC	-		
J18	VCC	-			J18	VCC	-		
J9	VCC	-			J9	VCC	-		
K8	VCC	-			K8	VCC	-		
L19	VCC	-			L19	VCC	-		
M19	VCC	-			M19	VCC	-		
N7	VCC	-			N7	VCC	-		
R20	VCC	-			R20	VCC	-		
R7	VCC	-			R7	VCC	-		
T19	VCC	-			T19	VCC	-		
V18	VCC	-			V18	VCC	-		
V8	VCC	-			V8	VCC	-		
V9	VCC	-			V9	VCC	-		
W10	VCC	-			W10	VCC	-		
W11	VCC	-			W11	VCC	-		
W16	VCC	-			W16	VCC	-		
W17	VCC	-			W17	VCC	-		
W18	VCC	-			W18	VCC	-		
W19	VCC	-			W19	VCC	-		
W8	VCC	-			W8	VCC	-		
W9	VCC	-			W9	VCC	-		
H12	VCCIO0	0			H12	VCCIO0	0		
H13	VCCIO0	0			H13	VCCIO0	0		
J10	VCCIO0	0			J10	VCCIO0	0		
J11	VCCIO0	0			J11	VCCIO0	0		
J12	VCCIO0	0			J12	VCCIO0	0		
J13	VCCIO0	0			J13	VCCIO0	0		
H14	VCCIO1	1			H14	VCCIO1	1		
H15	VCCIO1	1			H15	VCCIO1	1		

Thermal Management

Thermal management is recommended as part of any sound FPGA design methodology. To assess the thermal characteristics of a system, Lattice specifies a maximum allowable junction temperature in all device data sheets. Designers must complete a thermal analysis of their specific design to ensure that the device and package do not exceed the junction temperature limits. Refer to the Thermal Management document to find the device/package specific thermal values.

For Further Information

For further information regarding Thermal Management, refer to the following located on the Lattice website at www.latticesemi.com.

- Thermal Management document
- Technical Note TN1052 - Power Estimation and Management for LatticeECP/EC and LatticeXP Devices
- Power Calculator tool included with Lattice's ispLEVER design tool, or as a standalone download from www.latticesemi.com/software

LatticeECP Commercial (Continued)

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFECP33E-3FN484C	360	-3	Lead-Free fpBGA	484	COM	32.8K
LFECP33E-4FN484C	360	-4	Lead-Free fpBGA	484	COM	32.8K
LFECP33E-5FN484C	360	-5	Lead-Free fpBGA	484	COM	32.8K

LatticeEC Industrial

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC1E-3QN208I	112	-3	Lead-Free PQFP	208	IND	1.5K
LFEC1E-4QN208I	112	-4	Lead-Free PQFP	208	IND	1.5K
LFEC1E-3TN144I	97	-3	Lead-Free TQFP	144	IND	1.5K
LFEC1E-4TN144I	97	-4	Lead-Free TQFP	144	IND	1.5K
LFEC1E-3TN100I	67	-3	Lead-Free TQFP	100	IND	1.5K
LFEC1E-4TN100I	67	-4	Lead-Free TQFP	100	IND	1.5K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC3E-3FN256I	160	-3	Lead-Free fpBGA	256	IND	3.1K
LFEC3E-4FN256I	160	-4	Lead-Free fpBGA	256	IND	3.1K
LFEC3E-3QN208I	145	-3	Lead-Free PQFP	208	IND	3.1K
LFEC3E-4QN208I	145	-4	Lead-Free PQFP	208	IND	3.1K
LFEC3E-3TN144I	97	-3	Lead-Free TQFP	144	IND	3.1K
LFEC3E-4TN144I	97	-4	Lead-Free TQFP	144	IND	3.1K
LFEC3E-3TN100I	67	-3	Lead-Free TQFP	100	IND	3.1K
LFEC3E-4TN100I	67	-4	Lead-Free TQFP	100	IND	3.1K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC6E-3FN484I	224	-3	Lead-Free fpBGA	484	IND	6.1K
LFEC6E-4FN484I	224	-4	Lead-Free fpBGA	484	IND	6.1K
LFEC6E-3FN256I	195	-3	Lead-Free fpBGA	256	IND	6.1K
LFEC6E-4FN256I	195	-4	Lead-Free fpBGA	256	IND	6.1K
LFEC6E-3QN208I	147	-3	Lead-Free PQFP	208	IND	6.1K
LFEC6E-4QN208I	147	-4	Lead-Free PQFP	208	IND	6.1K
LFEC6E-3TN144I	97	-3	Lead-Free TQFP	144	IND	6.1K
LFEC6E-4TN144I	97	-4	Lead-Free TQFP	144	IND	6.1K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC10E-3FN484I	288	-3	Lead-Free fpBGA	484	IND	10.2K
LFEC10E-4FN484I	288	-4	Lead-Free fpBGA	484	IND	10.2K
LFEC10E-3FN256I	195	-3	Lead-Free fpBGA	256	IND	10.2K
LFEC10E-4FN256I	195	-4	Lead-Free fpBGA	256	IND	10.2K
LFEC10E-3QN208I	147	-3	Lead-Free PQFP	208	IND	10.2K
LFEC10E-4QN208I	147	-4	Lead-Free PQFP	208	IND	10.2K